<u>TOSHIBA</u>

TOSHIBA Photocoupler Photo Relay

TLP797J

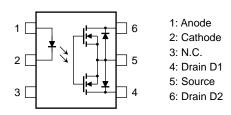
Telecommunication Measurement Instrumenation FA

The TOSHIBA TLP797J consists of an aluminum gallium arsenide infrared emitting diode optically coupled to a photo-MOS FET in a six lead plastic DIP package (DIP6).

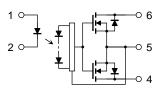
The TLP797J is a bi-directional switch can replace mechanical relays in many applications.

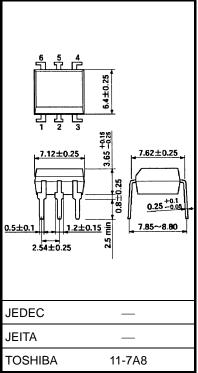
- 6 pin DIP (DIP6)
- 1-form-A
- Peak off-state voltage: 600 V (min)
- Trigger LED current: 5 mA (max)
- On-state current: 100 mA (max)
- On-state resistance: 35Ω (max)
- Isolation voltage: 5000 Vrms (min)

Pin Configurations (top view)



Schematic





Weight: 0.4 g (typ.)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics			Symbol	Rating	Unit	
	Forward current		١ _F	50	mA	
	Forward current de $(Ta \ge 25^{\circ}C)$	erating	∆I _F /°C	-0.5	mA/°C	
LED	Peak forward curre (100 μs pulse, 100		I _{FP}	1	А	
	Reverse voltage		V _R	5	V	
	Junction temperate	ure	Tj	125	°C	
	Off-state output ter	minal voltage	VOFF	600	V	
	On-state current	A connection		100		
		B connection	I _{ON}	100	mA	
Detector		C connection		200		
Delector	On-state current derating	A connection		-1.0		
		B connection	∆l _{ON} /°C	-1.0	mA/°C	
	(Ta ≥ 25°C)	C connection		-2.0		
	Junction temperate	ure	Тj	125	°C	
Storage temperature range			T _{stg}	T _{stg} –55 to 125		
Operating temperature range			T _{opr}	-40 to 85	°C	
Lead solde	Lead soldering temperature (10 s)			260	°C	
Isolation voltage (AC, 1 minute, R.H. ≤ 60%) (Note)			BVS	5000	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

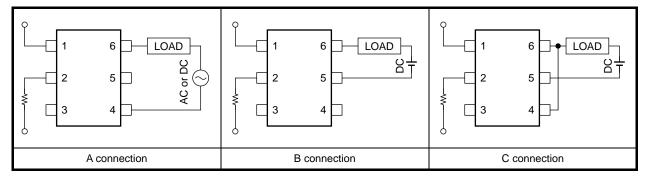
Note: Device considered a two-terminal device: Pins 1, 2 and 3 shorted together, and pins 4, 5 and 6 shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	V _{DD}			480	V
Forward current	١ _F	7.5	15	25	mA
On-state current	I _{ON}	_	_	100	mA
Operating temperature	T _{opr}	-20		65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Circuit Connections



Individual Electrical Characteristics (Ta = 25°C)

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	Ι _R	$V_R = 5 V$	_	_	10	μA
	Capacitance	CT	V = 0, f = 1 MHz	_	30	_	pF
Detector	Off-state current	I _{OFF}	V _{OFF} = 600 V	_	_	1	μA
	Capacitance	C _{OFF}	V = 0, f = 1 MHz		120	_	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		I _{FT}	I _{ON} = 100 mA	_	1.6	5	mA
Close LED current		I _{FC}	I _{OFF} = 100 μA	0.1	_	_	mA
On-state resistance	A connection	R _{ON}	I_{ON} = 100 mA, I_F = 10 mA, t < 1 s	_	25	35	Ω
	A connection		I _{ON} = 100 mA, I _F = 10 mA	_	30	45	
	B connection		I _{ON} = 100 mA, I _F = 10 mA	_	23	35	52
	C connection		$I_{ON} = 200 \text{ mA}, I_F = 10 \text{ mA}$		12		

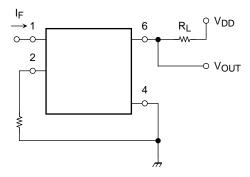
Isolation Characteristics (Ta = 25°C)

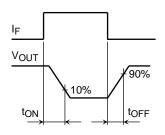
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	V _S = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	R _S	$V_S=500~V,~R.H.\leq 60\%$	5 × 10 ¹⁰	10 ¹⁴		Ω
Isolation voltage	BVS	AC, 1 minute	5000	_	_	Vrms
		AC, 1 s (in oil)	_	10000	_	vins
		DC, 1 minute (in oil)	_	10000	_	Vdc

Switching Characteristics (Ta = 25°C)

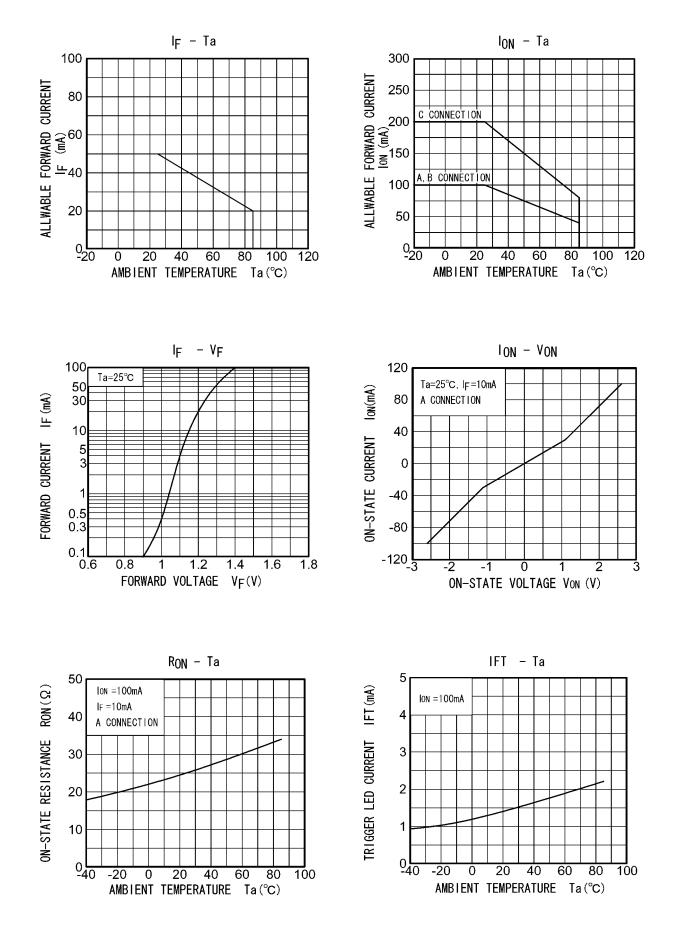
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t _{ON}	R _L = 200 Ω (No	e) —	0.2	1.5	ms
Turn-off time	tOFF	$V_{DD} = 20 \text{ V}, \text{ I}_{\text{F}} = 10 \text{ mA}$	—	0.2	1	ms

Note: Switching time test circuit

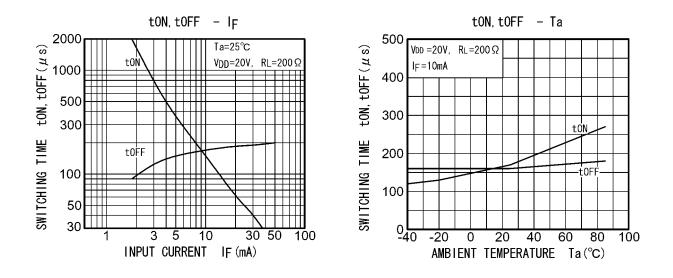




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